

STE60N105DK5

N-channel 1050 V, 0.110 Ω typ., 46 A MDmesh™ DK5 Power MOSFET in an ISOTOP package

Datasheet - production data

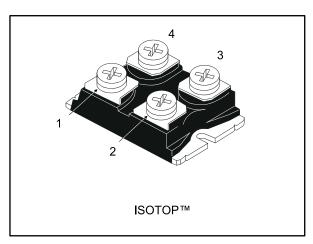
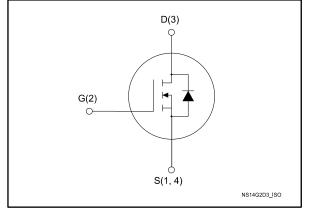


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	Ртот
STE60N105DK5	1050 V	0.120 Ω	46 A	680 W

- Fast-recovery body diode
- Best R_{DS(on)} x area
- Low gate charge, input capacitance and resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness

Applications

Switching applications

Description

This very high voltage N-channel Power MOSFET is part of the MDmesh $^{\text{TM}}$ DK5 fast recovery diode series. The MDmesh $^{\text{TM}}$ DK5 combines very low recovery charge (Qrr) and recovery time (trr) with an excellent improvement in RDS(on) * area and one of the most effective switching behaviors, ideal for half bridge and full bridge converters.

Table 1: Device summary

Order code	Marking	Packages	Packaging
STE60N105DK5	60N105DK5	ISOTOP	Tube

Contents STE60N105D		STE60N105DK5	
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STE60N105DK5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	±30	V
1_	Drain current (continuous) at T _C = 25 °C	46	Α
l _D	Drain current (continuous) at T _C = 100 °C	30	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	184	Α
P _{TOT}	Total dissipation at T _C = 25 °C	680	W
dv/dt (2)	Peak diode recovery voltage slope	50	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Viso	Insulation withstand voltage (AC-RMS)	2.5	kV
Tj	Operating junction temperature range	FF to 1F0	°C
T _{stg}	Storage temperature range		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.184	°C/W
R _{thj-amb}	Thermal resistance junction-ambient 30		C/VV

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
las	Single pulse avalanche energy (pulse width limited by T _{JMAX})	16	Α
Eas	Single pulse avalanche energy (starting $T_J = 25^{\circ}C$, $I_D = I_{AS}$, $V_{DD} = 50 \text{ V}$)	1550	mJ

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \le 23~A,~di/dt \le 400~A/\mu s;~V_{DS~peak} \le V_{(BR)DSS},~V_{DD} = 525~V$

 $^{^{(3)}}V_{DS} \le 840 \text{ V}$

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	1050			V
	Zara gata valtaga drain	V _{DS} = 1050 V, V _{GS} = 0 V			1	μΑ
IDSS	Zero gate voltage drain current	$V_{DS} = 1050 \text{ V}, V_{GS} = 0 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
I _{GSS}	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _G S = 10 V, I _D = 23 A		0.110	0.120	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance	100 V (1 MII	ı	6675	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	ı	370	-	pF
Crss	Reverse transfer capacitance	VGS - 0 V	ı	10	-	pF
C _{o(tr)} (1)	Equivalent capacitance time related	elated		630	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ to } 840 \text{ V}$	ı	219	-	
R _G	Intrinsic gate resistance f = 1 MHz open drain		ı	3	-	Ω
Q_g	Total gate charge $V_{DD} = 840 \text{ V}, I_D = 46 \text{ A},$		ı	204	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	36	-	nC
Q_gd	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	133	-	nC

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .



⁽¹⁾Defined by design, not subject to production test

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 525 \text{ V}, I_D = 23 \text{ A},$	-	40.6	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	64.5	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times"	-	262	-	ns
t _f	Fall time	and Figure 19: "Switching time waveform")	-	49.5	-	ns

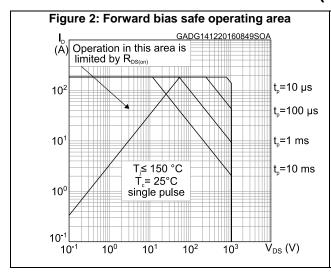
Table 8: Source drain diode

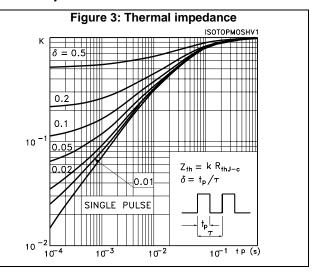
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		46	Α
I _{SDM}	Source-drain current (pulsed)		-		184	Α
V _{SD} ⁽¹⁾	Forward on voltage	I _{SD} = 46 A, V _{GS} = 0 V	ı		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 46 \text{ A}, V_{DD} = 60 \text{ V},$	ı	273		ns
Q_{rr}	Reverse recovery charge	di/dt = 100 A/µs (see <i>Figure 16: "Test circuit for</i>	-	3		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	1	23		A
t _{rr}	Reverse recovery time	I _{SD} = 46 A, V _{DD} = 60 V,	-	477		ns
Qrr	Reverse recovery charge	di/dt = 100 A/ μ s, T _j = 150 °C (see <i>Figure 16: "Test circuit for</i>	-	10		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")		42		А

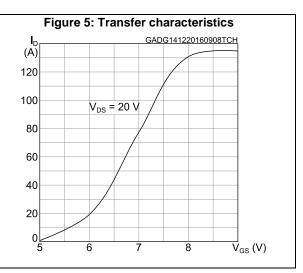
Notes:

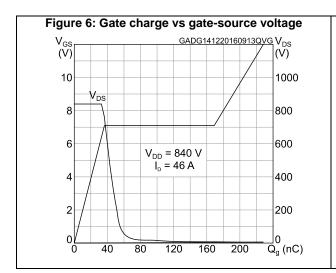
 $^{^{(1)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

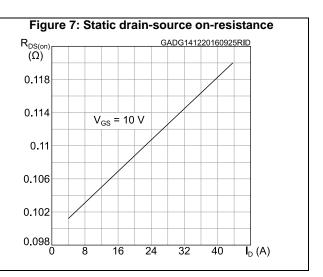
2.1 Electrical characteristics (curves)



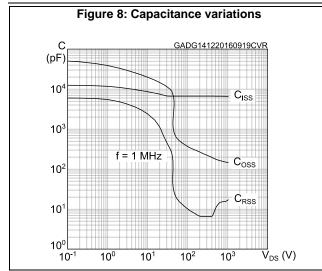








STE60N105DK5 Electrical characteristics



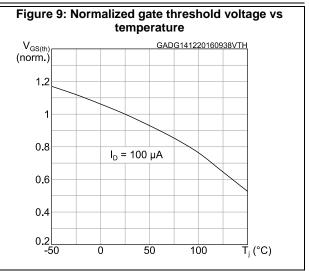
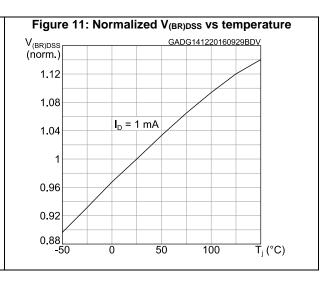
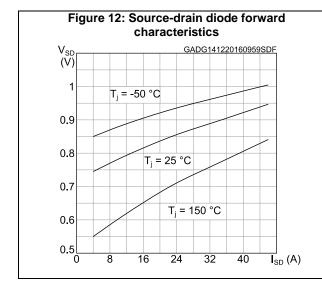
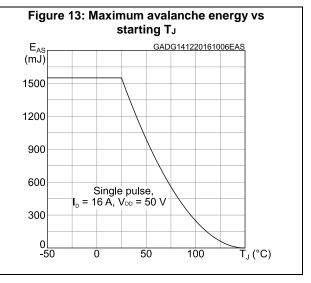


Figure 10: Normalized on-resistance vs temperature $R_{DS(on)}$ (norm.) $C_{GADG141220161004RON}$ $C_{GADG141220161004RON$

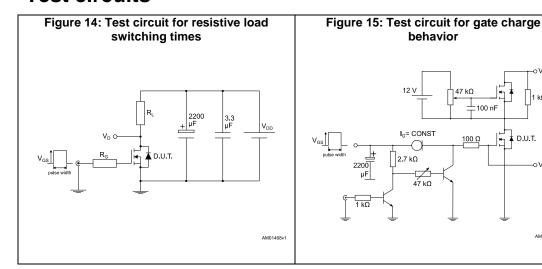


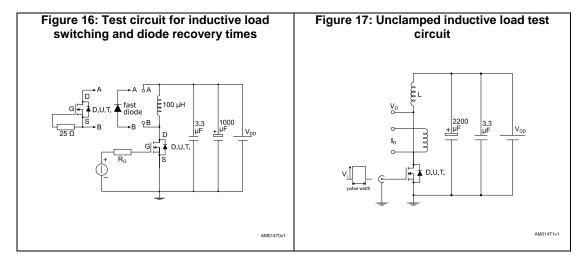


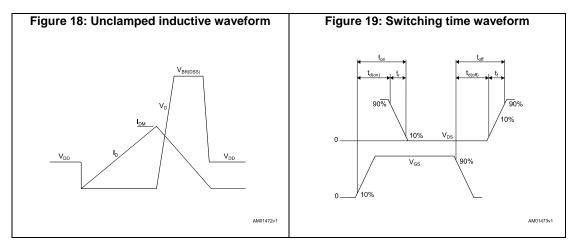


Test circuits STE60N105DK5

3 **Test circuits**







1 kΩ

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

Package information

4.1 ISOTOP package information

Figure 20: ISOTOP outline

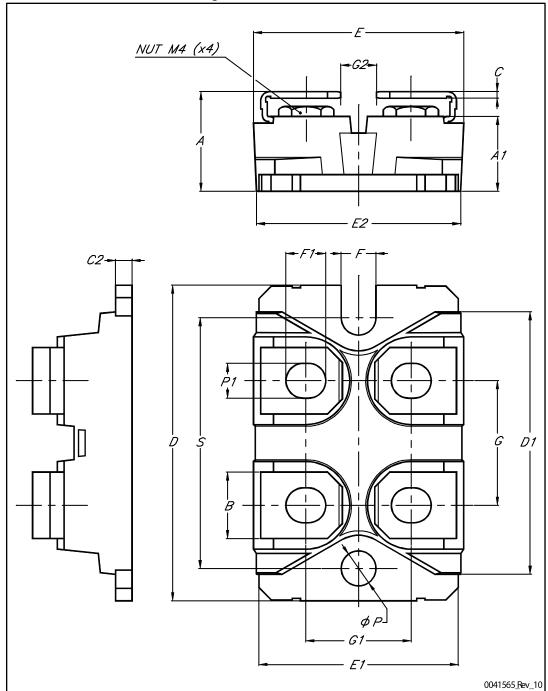


Table 9: ISOTOP mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	11.80		12.20
A1	8.90		9.10
В	7.80		8.20
С	0.75		0.85
C2	1.95		2.05
D	37.80		38.20
D1	31.50		31.70
Е	25.15		25.50
E1	23.85		24.15
E2		24.80	
G	14.90		15.10
G1	12.60		12.80
G2	3.50		4.30
F	4.10		4.30
F1	4.60		5
ØP	4		4.30
P1	4		4.40
S	30.10		30.30

Revision history STE60N105DK5

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
24-Jan-2013	1	First release
16-Dec-2016	2	Datasheet status promoted from preliminary to production data. Updated title, features, description and internal schematic diagram on cover page. Updated Section 1: "Electrical ratings". Updated Section 2: "Electrical characteristics". Added Section 2.1: "Electrical characteristics (curves)". Minor text changes

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